

Thin Film Chip Fuse



FEATURES

- Advanced thin film technology
- AEC-Q200 qualified ⁽¹⁾
- Very quick acting fuse characteristics
- Outstanding stability of fusing characteristics
- Advanced sulfur resistance verified according to ASTM B 809
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

MFU AT thin film chip fuses are the perfect choice for automotive electronics. The highly controlled manufacturing thin film process guarantees an outstanding stability of fusing characteristics. Typical automotive applications include electro vehicle and hybrid electro vehicle, battery management and circuit protection for small loads.

APPLICATIONS

- Electro vehicle
- Hybrid electro vehicle
- Battery management
- Circuit protection of small loads

TECHNICAL SPECIFICATIONS	
DESCRIPTION	MFU 0603-FF AT
Imperial size	0603
Metric size code	RR1608M
Rated current range I_R	0.5 A to 5.0 A
Rated voltage, U_{max} DC	32 V up to 63 V
Breaking capacity, I_{max} at U_{max} DC	50 A at U_{max} DC
Voltage drop at $1 \times I_R$	85 mV to 361 mV
Cold resistance at $0.1 \times I_R$	13 mΩ to 500 mΩ
Permissible film temperature, $\vartheta_{F max}$	125 °C
Operating temperature range	-55 °C to 125 °C
Permissible continuous current rating at $\vartheta_{amb} = 23$ °C	$0.7 \times I_R$
Approval UL / CSA recognition file	E253806
Failure rate: FIT _{observed}	$\leq 0.2 \times 10^{-9}/h$

Note

⁽¹⁾ According to Vishay's automotive chip fuse qualification requirements



PACKAGING						
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
MFU 0603 AT	P1	1000	Paper tape acc. IEC 60286-3 Type 1a	8 mm	4 mm	180 mm / 7"
	P5	5000				330 mm / 13"
	PW	20 000				

PART NUMBER AND PRODUCT DESCRIPTION																	
Part Number: MFU0603FF01000P5AT																	
M	F	U	0	6	0	3	F	F	0	1	0	0	0	P	5	A	T
TYPE / SIZE		FUSING CHARACTERISTIC				RATED CURRENT			PACKAGING			SPECIAL					
MFU0603		FF = very quick acting				Examples: 0.5 A = 00500 1.0 A = 01000			P1 P5 PW			Up to 2 digits AT = automotive					
Product Description: MFU 0603 - FF AT P5 1A0																	
MFU		0603		- FF		AT		P5		1A0							
TYPE		SIZE		FUSING		VERSION		PACKAGING		RATED CURRENT							
MFU		0603		FF = very quick acting		AT = automotive		P1 P5 PW		Examples: 0.5 A = 0A5 1.0 A = 1A0							

Note

- Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION

MFU 0603 AT RATING - Very quick acting (FF)										
SIZE	FUSE CHAR.	RATED CURRENT	RATED VOLTAGE	PRE-ARCING I^2t at $10 \times I_R$	VOLT. DROP ⁽¹⁾ at $1 \times I_R$	COLD RESIS. ⁽¹⁾ at $0.1 \times I_R$	BREAKING CAPACITY DC	MARK.	APPROVAL	PART NUMBER ⁽²⁾⁽³⁾
0603	FF	500 mA	63 V	0.0009 A ² s	361 mV	500 mΩ	50 A at 63 V	F	UL / CSA	MFU0603FF00500P5AT
		750 mA	50 V	0.0020 A ² s	258 mV	262 mΩ	50 A at 50 V	G	UL / CSA	MFU0603FF00750P5AT
		1.0 A	50 V	0.0028 A ² s	223 mV	170 mΩ	50 A at 50 V	H	UL / CSA	MFU0603FF01000P5AT
		1.5 A	50 V	0.0059 A ² s	155 mV	79 mΩ	50 A at 50 V	K	UL / CSA	MFU0603FF01500P5AT
		2.0 A	50 V	0.0101 A ² s	150 mV	57 mΩ	50 A at 50 V	N	UL / CSA	MFU0603FF02000P5AT
		2.5 A	50 V	0.0157 A ² s	121 mV	37 mΩ	50 A at 50 V	O	UL / CSA	MFU0603FF02500P5AT
		3.0 A	50 V	0.0227 A ² s	126 mV	32 mΩ	50 A at 50 V	P	UL / CSA	MFU0603FF03000P5AT
		3.5 A	32 V	0.0308 A ² s	106 mV	23 mΩ	50 A at 32 V	R	UL / CSA	MFU0603FF03500P5AT
		4.0 A	32 V	0.0403 A ² s	100 mV	19 mΩ	50 A at 32 V	S	UL / CSA	MFU0603FF04000P5AT
		5.0 A	32 V	0.2275 A ² s	85 mV	13 mΩ	50 A at 32 V	T	UL / CSA	MFU0603FF05000P5AT

Notes

- (1) Typical values
- (2) For packages with 1000 pieces, please use for packaging P1 instead of P5
- (3) For packages with 20 000 pieces, please use for packaging PW instead of P5



DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic substrate (Al₂O₃). The fuse elements are covered by a protective coating designed for electrical, mechanical, and climatic protection. The terminations receive a final pure matte tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual fuses. Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3, Type 1a** ⁽¹⁾.

ASSEMBLY

The fuses are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapor phase as shown in **IEC 61760-1**. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The fuses are RoHS-compliant; the pure matte tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein ⁽²⁾
- The Global Automotive Declarable Substance List (GADSL) ⁽³⁾
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) ⁽⁴⁾ for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

APPROVALS

The fuses are tested in accordance with the following standards:

- UL 248-14

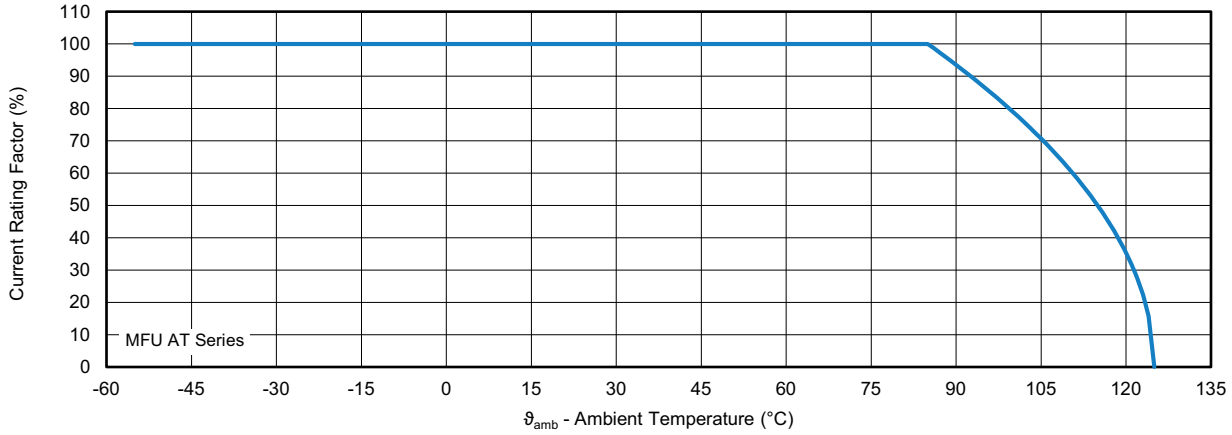
Approval of recognition by Underwriter Laboratories Inc. is indicated by the CSA / UL logo on the package label.

Notes

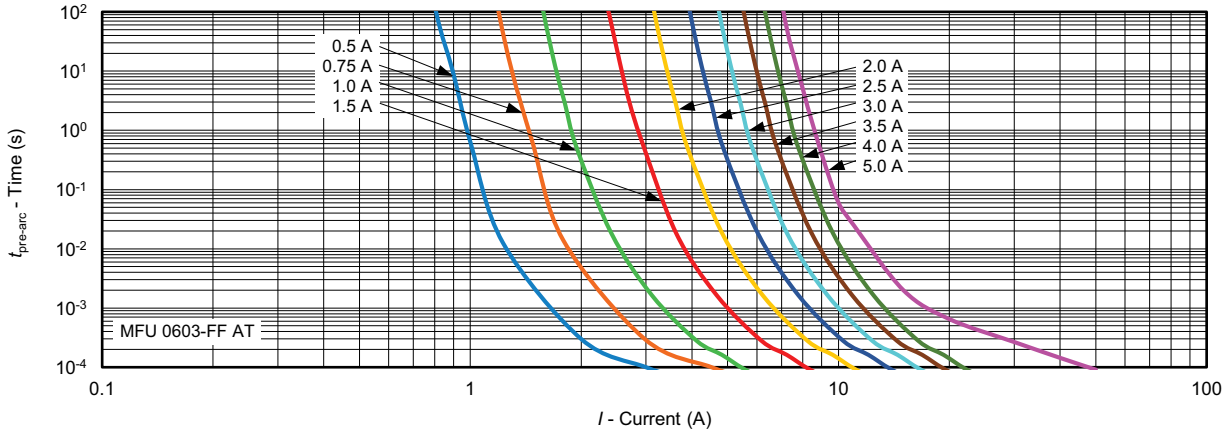
- ⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents
- ⁽²⁾ The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at <http://std.iec.ch/iec62474>
- ⁽³⁾ The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at www.gadsl.org
- ⁽⁴⁾ The SVHC list is maintained by the European Chemical Agency (ECHA) and available at <http://echa.europa.eu/candidate-list-table>



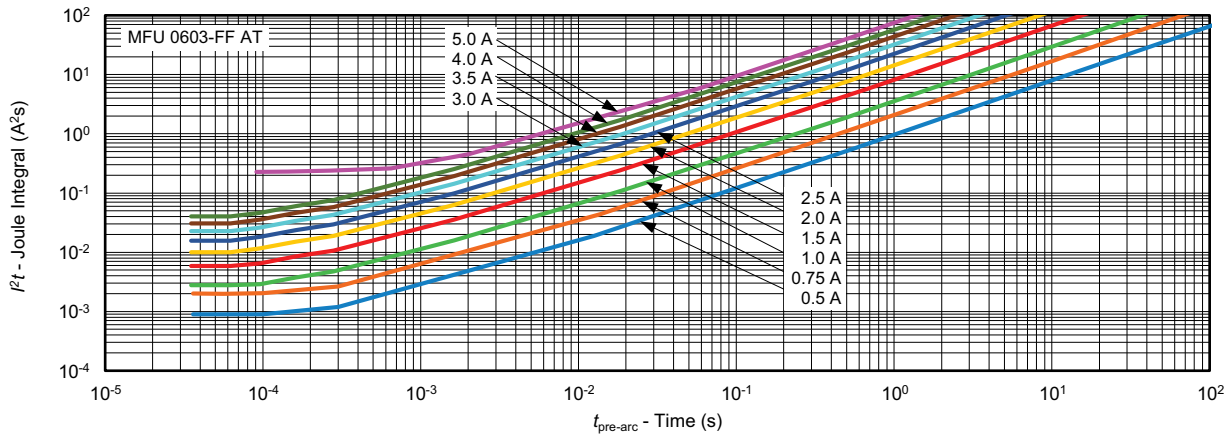
FUNCTIONAL PERFORMANCE



Current Rating Factor (1) vs. Ambient Temperature ϑ_{amb}



Typical $t_{pre-arc}$ vs. I Characteristic of MFU 0603 AT (2)



Typical I^2t vs. $t_{pre-arc}$ Characteristic of MFU 0603 AT (2)

Notes

- (1) Current rating factor is in addition to the given permissible continuous current rating of 0.7
- (2) Fuses mounted on a test board according to IEC 60127-4



TEST AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

IEC 60127-1, Miniature fuse - Part 1: definitions for miniature fuses and general requirements for miniature fuse-links

IEC 60127-4, Universal Modular Fuse Links (UMF)

UL 248-14, Low voltage fuses - Part 14: supplemental fuses
 AEC-Q200, Rev D June 1, 2010 according to Table 7 wherever applicable

For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by METI and CCC.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3. Climatic category LCT/UCT/56 (rated temperature range: lower category temperature, upper category temperature; damp heat, long term, 56 days) is valid.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

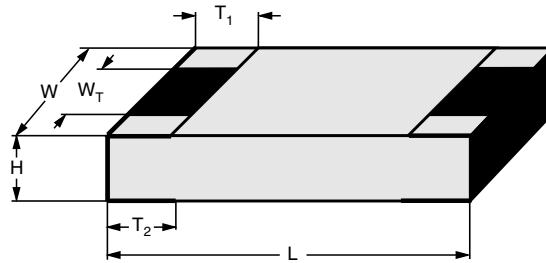
The components are mounted for testing on printed-circuit boards in accordance with IEC 60127-4, unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of IEC 60127-1 and IEC 60127-4 respectively. Where applicable some additional tests required by AEC-Q200 Table 7 Table of Methods referenced Resistors and its equivalent IEC 60068-2 environmental tests have been included.

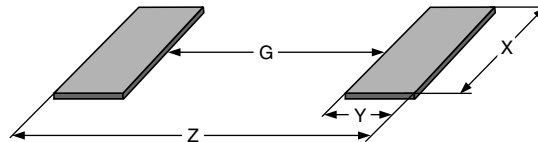
TEST PROCEDURES AND REQUIREMENTS						
IEC 60127-4 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE			REQUIREMENTS PERMISSIBLE CHANGE
8.3.2	21 (U _{e1})	Substrate bending	Depth 3 mm; rate 1 mm/s 1 times			No visible damage $\Delta R/R \leq \pm 15 \%$
8.6.2	58 (Td)	Solderability	Solder bath method; SnPb40; non-activated flux; (215 ± 3) °C; (3 ± 0.3) s			Good tinning (≥ 95 % covered); no visible damage
			Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s			
8.7.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s			No visible damage $\Delta R/R \leq \pm 15 \%$
			Reflow method 2 (IR/forced gas convection); (260 ± 5) °C; (10 ± 1) s			
9.2.1	-	Time/current characteristics at nominal temperature	Cold resistance at 0.1 x I _R ; destructive testing under overcurrent conditions (DC-current)	MFU 0603 AT	I _R ≤ 5.0 A	At 1.25 x I _R , t _{pre-arc} > 1 h at 2.0 x I _R , t _{pre-arc} < 10 s at 10 x I _R , t _{pre-arc} < 0.001 s
9.3.2	-	Breaking capacity	50 A at rated voltage acc. to UL 248-14			Optical inspection with naked eye no visible damage
9.3.3	-	Residual resistance	50 A at rated voltage acc. to UL 248-14			Insulation resistance at 2.0 x U _R (DC) higher than 0.1 MΩ
9.4	-	Endurance test acc. to IEC 60127-1	a) I = 1.0 x I _R (DC) 1.0 h on; 0.25 h off; 23 °C; 100 times	MFU 0603 AT	I _R ≤ 5.0 A	No visible damage $\Delta R/R \leq \pm 15 \%$
			b) I = 1.25 x I _R (DC) 1.0 h on 23 °C; 1 time			



TEST PROCEDURES AND REQUIREMENTS						
IEC 60127-4 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE			REQUIREMENTS PERMISSIBLE CHANGE
9.5	-	Maximum sustained dissipation acc. to IEC 60127-1	Calculation in accordance with results of clause 9.4 b)			Dissipation ≤ acc. to IEC 60127-4 table 2
9.7	-	Fuse-link temperature	The test is performed during the final 5 min of clause 9.4 b)	MFU 0603 AT	$I_R \leq 5.0 \text{ A}$	Temperature rise of terminals ≤ 95 K
-	-	Verification of temperature rise and current-carrying capacity acc. to UL 248-14 clause 8.2.3	$I = 1.0 \times I_R \text{ (DC)}$	MFU 0603 AT	$I_R \leq 5.0 \text{ A}$	Temperature rise of hot spot ≤ 75 K acc. to UL 248-14 clause 8.2.4
-	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH			$\Delta R/R \leq \pm 15 \%$ I-t characteristic
-	67 (Cy)	Damp heat, steady state, accelerated	(85 ± 2) °C; (85 ± 5) % RH; 1000 h			$\Delta R/R \leq \pm 15 \%$
-	14 (Na)	Rapid change of temperature	30 min at LCT; 30 min at UCT; LCT = -55 °C; UCT = 125 °C; 1000 cycles			$\Delta R/R \leq \pm 15 \%$
-	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s ² ; 6 h			$\Delta R/R \leq \pm 15 \%$
-	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2			No visible damage
-	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush			Marking legible, no visible damage
-	21 (Ue ₃)	Shear (adhesion)	9 N			No visible damage
-	-	Flammability	IEC 60695-11-5, needle flame test; 10 s			No burning after 30 s

DIMENSIONS


DIMENSIONS AND MASS							
TYPE / SIZE	H (mm)	L (mm)	W (mm)	WT (mm)	T ₁ (mm)	T ₂ (mm)	MASS (mg)
MFU 0603 AT	0.45 + 0.1 / - 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15 / - 0.2	0.3 + 0.15 / - 0.2	1.9

SOLDER PAD DIMENSIONS


RECOMMENDED SOLDER PAD DIMENSIONS								
TYPE / SIZE	WAVE SOLDERING				REFLOW SOLDERING			
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
MFU 0603 AT	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05

Note

- The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters



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